Analog Multiplexers/ Demultiplexers with Injection Current Effect Control with LSTTL Compatible Inputs

Automotive Customized

MC74HCT4851A, MC74HCT4852A

This device is pin compatible to standard HC405x and MC1405xB analog mux/demux devices, but feature injection current effect control. This makes them especially suited for usage in automotive applications where voltages in excess of normal logic voltage are common.

The injection current effect control allows signals at disabled analog input channels to exceed the supply voltage range without affecting the signal of the enabled analog channel. This eliminates the need for external diode/ resistor networks typically used to keep the analog channel signals within the supply voltage range.

The devices utilize low power silicon gate CMOS technology. The Channel Select and Enable inputs are compatible with standard CMOS or LSTTL outputs.

Features

- Injection Current Cross–Coupling Less than 1mV/mA (See Figure 6)
- Pin Compatible to HC405x and MC1405xB Devices
- Power Supply Range (V_{CC} GND) = 4.5 to 5.5 V
- In Compliance With the Requirements of JEDEC Standard No. 7 A
- Chip Complexity: 154 FETs or 36 Equivalent Gates
- NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant



ORDERING INFORMATION

See detailed ordering and shipping information on page 11 of this data sheet.

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Figure 1. MC74HCT4851A Logic Diagram Single–Pole, 8–Position Plus Common Off

FUNCTION TABLE - MC74HCT4851A



Figure 2. MC74HCT4851A 16-Lead Pinout (Top View)

FUNCTION TABLE - MC74HCT4852A

Control Inputs				
Select				
Enable	В	Α	ON Ch	annels
L	L	L	Y0	X0
L	L	Н	Y1	X1
L	н	L	Y2	X2
L	н	Н	Y3	X3
Н	Х	Х	NC	NE





Figure 4. MC74HCT4852A 16-Lead Pinout (Top View)





MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V _{CC}	Positive DC Supply Voltage (Referenced to GND)	-0.5 to + 7.0	V
V _{in}	DC Input Voltage (Any Pin) (Referenced to GND)	–0.5 to V _{CC} + 0.5	V
I	DC Current, Into or Out of Any Pin	±25	mA
PD	Power Dissipation in Still Air, SOIC Package† TSSOP Package†	500 450	mW
T _{stg}	Storage Temperature Range	65 to + 150	°C
ΤL	Lead Temperature, 1 mm from Case for 10 Seconds SOIC or TSSOP Package	260	°C

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation, V_{in} and V_{out} should be constrained to the range GND \leq (V_{in} or V_{out}) \leq V_{CC}.

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or V_{CC}). Unused outputs must be left open.

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Max	Unit	
V _{CC}	Positive DC Supply Voltage (Refe	renced to GND)	4.5	5.5	V
V _{in}	DC Input Voltage (Any Pin) (Refe	renced to GND)	GND	V _{CC}	V
V _{IO} *	Static or Dynamic Voltage Across Switch		0.0	1.2	V
T _A	Operating Temperature Range, All Package Types		- 55	+ 125	°C
t _r , t _f	Input Rise/Fall Time (Channel Select or Enable Inputs)	$V_{CC} = 2.0 V$ $V_{CC} = 4.5 V$ $V_{CC} = 6.0 V$	0 0 0	1000 500 400	ns

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

*For voltage drops across switch greater than 1.2 V (switch on), excessive V_{CC} current may be drawn; i.e., the current out of the switch may contain both V_{CC} and switch input components. The reliability of the device will be unaffected unless the Maximum Ratings are exceeded.

DC CHARACTERISTICS — Digital Section (Voltages Referenced to GND) V_{EE} = GND, Except Where Noted

			Guaranteed Limit		nit		
Symbol	Parameter	Condition	v	–55 to 25°C	≤ 85°C	≤125°C	Unit
V _{IH}	Minimum High-Level Input Voltage, Channel-Select or Enable Inputs	R _{on} = Per Spec	4.5 to 5.5	2.0	2.0	2.0	V
VIL	Maximum Low-Level Input Voltage, Channel-Select or Enable Inputs	R _{on} = Per Spec	4.5 to 5.5	0.8	0.8	0.8	V
l _{in}	Maximum Input Leakage Current on Digital Pins (Enable/A/B/C)	V _{in} = V _{CC} or GND	5.5	± 0.1	± 1.0	± 1.0	μΑ
I _{CC}	Maximum Quiescent Supply Current (per Package)	V _{in(digital)} = V _{CC} or GND V _{in(analog)} = GND	5.5	2.0	20	40	μΑ

DC CHARACTERISTICS — Analog Section

				Guaranteed Limit			
Symbol	Parameter	Condition	v _{cc}	–55 to 25°C	≤ 85°C	≤125°C	Unit
R _{on}	Maximum "ON" Resistance	$\label{eq:Vin} \begin{array}{l} V_{in} = V_{IL} \text{ or } V_{IH}; \ V_{IS} = V_{CC} \text{ to} \\ \text{GND (Note 1); } I_S \leq 2.0 \text{ mA} \\ \text{(Note 2)} \end{array}$	4.5 5.5	550 400	650 500	750 600	Ω
ΔR_{on}	Delta "ON" Resistance	$\label{eq:Vin} \begin{array}{l} V_{in} = V_{IL} \mbox{ or } V_{IH}; \ V_{IS} = V_{CC}/2 \\ \mbox{(Note 1); } I_S \leq 2.0 \mbox{ mA (Note 2)} \end{array}$	4.5 5.5	80 60	100 80	120 100	Ω
I _{off}	Maximum Off-Channel Leakage Current, Any One Channel Common Channel	V _{in} = V _{CC} or GND	5.5	±0.1 ±0.1	±0.1 ±0.1	±0.1 ±0.1	μΑ
I _{on}	Maximum On-Channel Leakage Channel-to-Channel	V _{in} = V _{CC} or GND	5.5	±0.1	±0.1	±0.1	μΑ

V_{IS} is the input voltage of an analog I/O pin.
 I_S is the currebnt flowing in or out of analog I/O pin.

AC CHARACTERISTICS (CL = 50 pF, Input t_{r} = t_{f} = 6 ns, V_{CC} = 5.0 V \pm 10%)

Symbol	Parameter		V _{cc}	–55 to 25°C	≤ 85°C	≤125°C	Unit
t _{PHL} , t _{PLH}	Maximum Propagation Delay, Analog In	n Propagation Delay, Analog Input to Analog Output		40	45	50	ns
t _{PHL} , t _{PHZ,PZH} t _{PLH} , t _{PLZ,PZL}	Maximum Propagation Delay, Enable or	pagation Delay, Enable or Channel-Select to Analog Output		80	90	100	ns
C _{in}	Maximum Input Capacitance (All Switches Off) (All Switches Off)	Digital Pins Any Single Analog Pin Common Analog Pin		10 35 40	10 35 40	10 35 40	pF
C _{PD}	Power Dissipation Capacitance	Typical	5.0	20			pF

INJECTION CURRENT COUPLING SPECIFICATIONS (V_{CC} = 5V, T_A = -55^{\circ}C to +125 $^{\circ}C$)

Symbol	Parameter	Condition	Тур	Max	Unit
V∆ _{out}	Maximum Shift of Output Voltage of Enabled Analog Channel	$ \begin{split} &I_{in}^{*} \leq 1 \text{ mA, } R_{S} \leq 3,9 \text{ k}\Omega \\ &I_{in}^{*} \leq 10 \text{ mA, } R_{S} \leq 3,9 \text{ k}\Omega \\ &I_{in}^{*} \leq 1 \text{ mA, } R_{S} \leq 20 \text{ k}\Omega \\ &I_{in}^{*} \leq 10 \text{ mA, } R_{S} \leq 20 \text{ k}\Omega \end{split} $	0.1 1.0 0.5 5.0	1.0 5.0 2.0 20	mV

* I_{in} = Total current injected into all disabled channels.

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GND or $V_{\rm SS}$

NOTES: Rs = $3.9 \text{ K}\Omega$ or $20 \text{ K}\Omega$.

Vm1 & Vm2 are internal HP4155C Voltmeters.

Figure 6. Injection Current Coupling Specification



Figure 7. Actual Technology Requires 32 passive components and one extra 6V regulator to suppress injection current into a standard HCT4051 multiplexer



Figure 8. MC74HCT4851A Solution Solution by applying the HCT4851A multiplexer



Figure 9. On Resistance Test Set-Up



Figure 10. Maximum Off Channel Leakage Current, Any One Channel, Test Set-Up



Figure 11. Maximum Off Channel Leakage Current, Common Channel, Test Set–Up



Figure 12. Maximum On Channel Leakage Current, Channel to Channel, Test Set–Up







*Includes all probe and jig capacitance





 $V_{\rm H} = GND$ to 3.0 $V_{\rm M} = 1.3$ V





*Includes all probe and jig capacitance

Figure 16. Propagation Delay, Test Set–Up Analog In to Analog Out















Figure 20. Diagram of Bipolar Coupling Mechanism Appears if V_{in} exceeds V_{CC}, driving injection current into the substrate



Figure 21. Function Diagram, HCT4851A



Figure 22. Function Diagram, HCT4852A

ORDERING INFORMATION

Device	Package	Shipping [†]		
MC74HCT4851ADG	SOIC-16	48 Units / Rail		
MC74HCT4851ADR2G	- (PD-Free)	2500 Units / Tape & Reel		
NLV74HCT4851ADRG*		2500 Units / Tape & Reel		
MC74HCT4851AADR2G	1	2500 Units / Tape & Reel		
NLV74HCT4851AADR2G* (Contact ON Semiconductor)		2500 Units / Tape & Reel		
MC74HCT4851ADTG	TSSOP-16	48 Units / Rail		
M74HCT4851ADTR2G	- (Pb-Free)	2500 Units / Tape & Reel		
NLVHCT4851ADTR2G*	1	2500 Units / Tape & Reel		
M74HCT4851ADWR2G	SOIC-16 WIDE (Pb-Free)	1000 Units / Tape & Reel		
MC74HCT4852ADG	SOIC-16	48 Units / Rail		
MC74HCT4852ADR2G	- (Pb-Free)	2500 Units / Tape & Reel		
MC74HCT4852ADTG	TSSOP-16	48 Units / Rail		
M74HCT4852ADTR2G	- (Pb-Free)	2500 Units / Tape & Reel		
NLVHCT4852ADTR2G*	1	2500 Units / Tape & Reel		

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.
 *NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q100 Qualified and PPAP

Capable.





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D	10.15	10.45
Е	7.40	7.60
е	1.27	BSC
Н	10.05	10.55
h	0.25	0.75
L	0.50	0.90
a	0 °	7 °

GENERIC **MARKING DIAGRAM***



XXXXX = Specific Device Code А

- = Assembly Location
- = Wafer Lot WL
- YY = Year

ww = Work Week

= Pb-Free Package G

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